System Product Data Sheet Edition 30/08/2006 Identification no: 02 05 02 03 004 System Sika® AcouBond®-System

Sika[®] AcouBond[®]-System

Footfall sound dampening system for wood flooring

System Description	The Sika [®] AcouBond [®] -System consists of a mat in two different thickness, SikaLayer [®] -03 (3 mm)/ SikaLayer [®] -05 (5 mm) and an elastic, sound dampening adhesive in three different versions: SikaBond [®] -T52, SikaBond [®] -T52 FC, SikaBond [®] -T53.		
Uses	The Sika [®] AcouBond [®] -System is used to bond solid wood boards, 3-ply engineered wood as well as chipboards (groove and tongue) in new constructions and especially for renovations in residential-, office-, and industrial buildings as well as sales- and show-rooms.		
Characteristics /	Footfall sound reduction up to 18 dB (DIN 52 210)		
Advantages	Reduce walking sound		
	Woodfloor bonded directly to subfloor		
	No outwearing of mat		
	Can be walked on during installation.		
	Quick and easy to lay (designated system).		
	Low adhesive consumption.		
	Suitable for common types of wood floors.		
	Suitable for bonding wood floors directly onto old tiles.		
	Reduces stress on the substrate.		
	Compensation of small substrate unevenness.		
	Adhesive can be sanded.		
Tests			
Approvals / Standards	Sika [®] AcouBond [®] -System with SikaLayer-03:		
	Sound Transmission Class 60: RAL™-TL01-222 (USA).		
	Impact Insulation Class 59: RAL™-IN01-12 (USA).		
	Reduction of Impact Sound Δ Lw 16 dB (NF EN ISO 717/2): Report 00A730e.		
	Reduction of Impact Noise DLw -3 dB (NF EN ISO 717/2): Report 00A731e.		
	Sika [®] AcouBond [®] -System with SikaLayer-05:		
	Sound Transmission Class 60: RAL™-TL01-221 (USA).		
	Impact Insulation Class 57: RAL™-IN01-11 (USA).		
	Reduction of Impact Sound Δ Lw 18 dB (NF EN ISO 717/2): Report 01A829e.		
	Reduction of Impact Noise DLw -3 dB (NF EN ISO 717/2): Report 01A828e.		



Product Description	SikaLayer [®] -Mats		
Uses	High-quality Polyethylene foam mat with symmetrically placed cut-outs to insert adhesive to achieve a high sound dampening effect.		
Characteristics / Advantages	 Dimensionally stable and pressure resistant Defined amount of adhesive consumption Low weight for transport 		
Form	SikaLayer [®] -03	SikaLayer [®] -05	
Colours	Grey	Grey	
Packaging	16.7 x 1.5 m rolls = 25 m ²	13.3 x 1.5 m rolls = 20 m^2	
Storage			
Storage Conditions / Shelf-Life	Unlimited if in dry conditions and protected from direct sunlight at temperatures between +10 $^\circ\!C$ and +25 $^\circ\!C$.		
Technical Data	SikaLayer [®] -03	SikaLayer [®] -05	
Chemical Base	PE foam	PE foam	
Thickness	3 mm	5 mm	
Density	$30 \text{ kg/m}^3 = 90 \text{ g/m}^2$	$30 \text{ kg/m}^3 = 150 \text{ g/m}^2$	
Cut Outs	60 /m ²	60 /m ²	
Heat Conductivity	0.042 W/mK	0.042 W/mK	
Footfall Sound Reduction	Up to 16 dB	Up to 18 dB	

Product Description	SikaBond [®] -Adhesiv	/es	
Uses	Insert SikaBond [®] -T52 FC, SikaBond [®] -T53 or SikaBond [®] -T52 to all cut-outs in the SikaLayer [®] mat for a predetermined fixation of wood floors.		
Characteristics / Advantages	 SikaLayer matter a predetermined fixation of wood hoors. 1-part, ready to use SikaBond[®]-T52 FC: solvent free, EC-1, odourless, fast curing SikaBond[®]-T52: solvent free, EC-1, odourless SikaBond[®]-T53: Fast curing Adhesives can be sanded For more detailed information see corresponding PDS 		
Form	SikaBond [®] -T52 FC	SikaBond [®] -T53	SikaBond [®] -T52
Colours	Parquet brown	Beige	Parquet brown
Packaging	600 ml sausages 1800 ml sausages	600 ml sausages 1800 ml sausages	600 ml sausages
Storage	SikaBond [®] -T52 FC	SikaBond [®] -T53	SikaBond [®] -T52
Storage Conditions / Shelf-Life	From date of production if stored in undamaged original sealed containers, in dry conditions and protected from direct sunlight at temperatures between +10 °C and +25 °C:		
	12 months	12 months	12 months
Technical Data	SikaBond [®] -T52 FC	SikaBond [®] -T53	SikaBond [®] -T52
Chemical Base	1-part Polyurethane, moist	ure curing	
Density	~ 1.28 kg/l (DIN 53 479)	~ 1.2 kg/l (DIN 53 479)	~ 1.29 kg/l (DIN 53 479)
Skinning- / Laying Time	∼ 60 minutes (+23℃ / 50% r. h.)	~ 45-60 minutes (+23℃ / 50% r. h.)	~ 60-90 minutes (+23℃ / 50% r. h.)
Curing Rate	~ 4 mm / 24 h (+23℃ / 50% r. h.)	~ 3 mm / 24 h (+23℃ / 50% r. h.)	~ 3 mm / 24 h (+23℃ / 50% r. h.)
		round 12-48 hours after inst hesive layer thickness). For d	
Sag Flow	Consistency: Easily applicable with gun.		
Service Temperature	-40 ℃ to+70 ℃, suitable for sub floor heating		
Mechanical / Physical Properties	SikaBond [®] -T52 FC	SikaBond [®] -T53	SikaBond [®] -T52
Shear Strength	~ 0.9 N/mm ² , 1 mm adhesive thickness (+23°C / 50% r. h.) (DIN 281)	~ 1.2 N/mm ² , 1 mm adhesive thickness (+23°C / 50% r. h.) (DIN 281)	~ 0.7 N/mm ² , 1 mm adhesive thickness (+23 °C / 50% r. h.) (DIN 281)
Tensile Strength	∼ 1.0 N/mm ² (+23℃ / 50% r. h.) (DIN 53 504)	∼ 1.8 N/mm ² (+23℃ / 50% r. h.) (DIN 53 504)	∼ 1.3 N/mm² (+23℃ / 50% r. h.) (DIN 53 504)
Shore A Hardness	∼ 30 after 28 days (+23 ℃ / 50% r. h.) (DIN 53 505)	∼ 40 after 28 days (+23 ℃ / 50% r. h.) (DIN 53 505)	∼ 30 after 28 days (+23℃ / 50% r. h.) (DIN 53 505)
Elongation at Break	∼ 600% after 28 days (+23℃ / 50% r. h.) (DIN 53 504)	~ 500% after 28 days (+23℃ / 50% r. h.) (DIN 53 504)	∼ 900% after 28 days (+23℃ / 50% r. h.) (DIN 53 504)

System Information			
System Structure	The system configuration as described must be fully complied with and may not l changed.		
Application Details	SikaBond [®] -T52 FC	SikaBond [®] -T53	SikaBond [®] -T52
Consumption	610 (03) - 770 (05) g/m ² (480 - 600 ml/m ²)	580 (03) - 720 (05) g/m ² (480 - 600 ml/m ²)	610 (03) - 770 (05) g/m ² (480 - 600 ml/m ²)
	Filling of all cut-outs is a mu	ust.	
	Use triangular nozzle with 8		
	1 box with 20 sausages has	s to be used for one roll of S	ikaLayer [®] -Mats.
Substrate Quality	Ostrate QualityClean and dry, homogeneous, even, free from grease, dust and loose particles. Paint, laitance and other poorly adhering particles must be removed.Standard construction rules must be observed.		
Substrate Preparation	Concrete / cement screed: Must be ground and thoroughly cleaned with industrial vacuum cleaner.		
	Anhydrite screed / Anhydrite flowable screed: Must be ground and thoroughly cleaned with industrial vacuum cleaner shortly before bonding starts.		
	Broadcast mastic asphalt: Must be primed with Sika [®] Primer MB. Instructions for use, see Product Data Shee for Sika [®] Primer MB.		
	Glazed ceramic and old ceramic tiles: Degrease, clean with SikaCleaner [®] or grind the tile-surface and clean thoroughly with an industrial vacuum cleaner.		
	Wood- / gypsum boards (e.g. chipboards, plywood): Glue / screw the boards to the substructure. They have to be fixed on the substrate In case of floating subfloors, please contact our Technical Service.		
	Unknown substrates: Please contact our Technical Service.		
	SikaBond [®] -T52 FC / -T53 / -T52 can be used without priming on cement floors, anhydrite floors, chip boards, concrete and ceramic tiles.		
	case of renovation on old a use Sika [®] Primer MB. For c	alt, cement floors with an ex dhesive residues and on str detailed instructions consult tour Technical Department.	cessive moisture content, in ucturally weak substrates the Product Data Sheet of
Application Conditions / Limitations			
Substrate Temperature	During laying and until SikaBond [®] -adhesives have fully cured substrate temperature must be > $+15 ^{\circ}$ C and in case of floor heating < $+20 ^{\circ}$ C.		
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		s the standard construction r	ules are relevant.
Ambient Temperature			ules are relevant.

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Substrate Moisture	Permissible substrate moisture content:		
Content	- 2.5% CM for cement screed (ca. 4% Tramex / Gravimetric weight percent).		
	- 0.5% CM for anhydrite screed.		
	- 3 - 12% CM for magnesia flooring (proportion of organic parts).		
	Permissible substrate moisture content in case of floor heating:		
	- 1.8% CM for cement screed (ca. 3% Tramex / Gravimetric weight percent).		
	- 0.3% CM for anhydrite screed.		
	- 3 - 12% CM for magnesia flooring (proportion of organic parts).		
	For moisture content and quality of substrates the guidelines of wood floor manufacturer as well as standard construction rules must be observed.		
Relative Air Humidity	Between 40% and 70%		
Application Instructions Application Method /	Place SikaLayer [®] -03 / -05 mat on the properly		
Tools	prepared substrate, parallel to the laying direction of the wood floor.		
	Please observe that the foam mats must be placed close to each other, however not overlapping.		
	To apply the adhesive, a sausage-gun is required.		
	Apply the adhesive with manual- or air-pressure-gun into all cut-outs with the supplied triangular nozzle (width 8 mm, height 10mm). Filling of all cut-outs is a must.		
	The nozzle must be held vertical to the substrate.		
	Adhesive may not be placed onto the mat between the cut-outs.		
	Position wood boards and firmly press into the adhesive until they lay tight on the SikaLayer [®] . The wood boards can then be joined together using a hammer and an impact block.		
	The required distance from the wall to the wood floor in the laying instruction from the wood floor manufacturer must be observed.		
	Fresh, uncured adhesive remaining on the wood floor surface must be removed immediately with a clean cloth and if necessary cleaned with Sika [®] Remover-208 Thinner C. Test wood floor surfaces for compatibility with Sika [®] Cleaner-208 / Thinner C beforuse.		
	The laying instructions of the wood floor manufacturer as well as standard construction rules must be observed.		
Cleaning of Tools	Clean all tools and application equipment with Sika [®] Remover-208 / Thinner C immediately after use. Hardened/cured material can only be mechanically remov		

Notes on Application / Limitations	 If, according to wood floor suppliers or producers deviation from the standards is permissible, temperatures between +5 °C and +35 °C must be observed for the adhesive. For better workability the adhesive temperature must be at least +15 °C. For the proper curing of the adhesive sufficient ambient moisture is necessary. For the Sika[®] AcouBond[®]-System accurate tongue and groove (min. 3 x 3 mm) are inevitable: 		
	Minimum wood size:	length > 300 mm (over 3 adhesive cordons) width > 50 mm thickness > 12 mm	
	Maximum wood size:	thickness < 28 mm	
	The application become	s more effective with long and wide boards (longstrips).	
	basement only with mois	n uninsulated areas, basements and grounds without sture regulator System Sikafloor [®] EpoCem and stailed instructions consult the Product Data Sheets or ervice.	
	In case of chemically pre-treated types of wood floors (e.g. ammonia, wood stain, timber preservative) and woods with high oil content SikaBond [®] is only to be used after a written recommendation from our Technical Department.		
	Do not use on PE, PP, TEFLON, and certain plastic synthetic materials (carry out pre-trials or contact our Technical Service).		
	Do not mix or expose SikaBond [®] to isocyanate reactive substances (e.g. these are usually parts of alcohol and thinner).		
	Some primers can negatively influence the adhesion of SikaBond $^{\ensuremath{\mathbb{B}}}$ (pre trials recommended).		
	When laying bonded wood flooring, always make sure that any wood surface sealer coatings do not come into contact with the adhesive. However if direct contact with the adhesive is unavoidable, then the compatibility of the sealing coats must always be checked and confirmed before use. For further information or assistance contact your local Sika Technical Department.		
Value Base		in this Product Data Sheet are based on laboratory tests. ay vary due to circumstances beyond our control.	
Local Restrictions	Please note that as a result of specific local regulations the performance of this product may vary from country to country. Please consult the local Product Data Sheet for the exact description of the application fields.		
Health and Safety Information	For information and advice on the safe handling, storage and disposal of chemical products, users should refer to the most recent Material Safety Data Sheet containing physical, ecological, toxicological and other safety-related data.		
Legal Notes	and end-use of Sika proc knowledge and experien applied under normal co practice, the differences that no warranty in respe- nor any liability arising o either from this informati advice offered. The user intended application and of its products. The prop are accepted subject to refer to the most recent	particular, the recommendations relating to the application ducts, are given in good faith based on Sika's current ice of the products when properly stored, handled and nditions in accordance with Sika's recommendations. In in materials, substrates and actual site conditions are such ect of merchantability or of fitness for a particular purpose, ut of any legal relationship whatsoever, can be inferred on, or from any written recommendations, or from any othe of the product must test the product's suitability for the purpose. Sika reserves the right to change the properties rietary rights of third parties must be observed. All orders our current terms of sale and delivery. Users must always issue of the local Product Data Sheet for the product ich will be supplied on request.	



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